

HMC443LP4 / 443LP4E

v04.0210



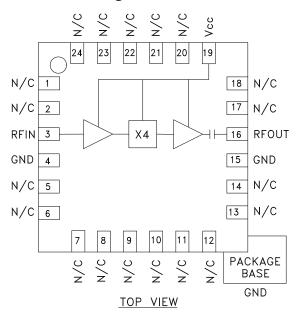
SMT GaAs HBT MMIC x4 ACTIVE FREQUENCY MULTIPLIER, 9.8 - 11.2 GHz OUTPUT

Typical Applications

Active Multiplier for X Band Applications:

- Fiber Optic
- Point-to-Point Radios
- Military Radar

Functional Diagram



Features

Output Power: +4 dBm

Sub-Harmonic Suppression: >25 dBc

SSB Phase Noise: -142 dBc/Hz

Single Supply: 5V@ 52 mA

24 Lead 4x4 mm SMT Package: 16 mm²

General Description

The HMC443LP4 & HMC443LP4E are active miniature x4 frequency multipliers utilizing InGaP GaAs HBT technology in 4x4 mm leadless surface mount packages. Power output is +4 dBm typical from a 5V supply voltage and varies little vs. input power, temperature and supply voltage. Suppression of undesired fundamental and sub-harmonics is >25 dBc typical with respect to output signal level. The low additive SSB phase noise of -142 dBc/Hz at 100 kHz offset helps the user maintain good system noise performance. The HMC443LP4 & HMC443LP4E are ideal for use in LO multiplier chains allowing reduced parts count vs. traditional approaches.

Electrical Specifications, $T_A = +25^{\circ}$ C, Vcc = 5V

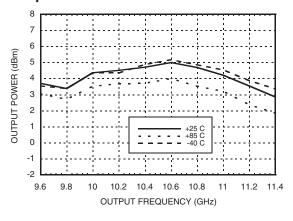
| Parameter | Min. | Тур. | Max. | Units |
|---|-------------|------|------|--------|
| Frequency Range, Input | 2.45 - 2.80 | | GHz | |
| Frequency Range, Output | 9.8 - 11.2 | | GHz | |
| Input Power Range | -15 | | +5 | dBm |
| Output Power | 1 | 4 | | dBm |
| Sub-Harmonic Suppression | | 25 | | dBc |
| Input Return Loss | | 15 | | dB |
| Output Return Loss | | 8 | | dB |
| SSB Phase Noise (100 kHz Offset) Pin= 0 dBm | | -142 | | dBc/Hz |
| Supply Current (Icc) | | 52 | 69 | mA |



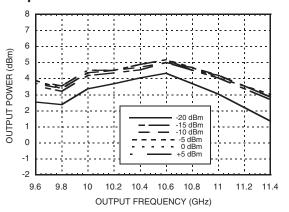


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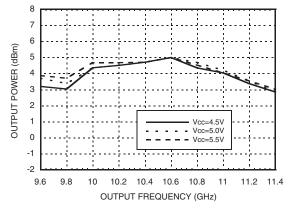
Output Power vs. Temperature @ -10 dBm Drive Level



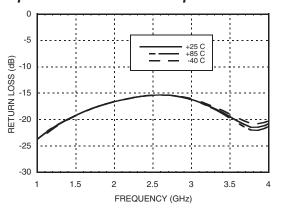
Output Power vs. Drive Level



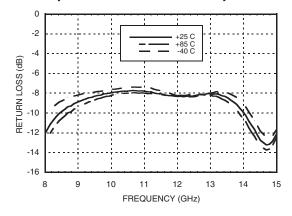
Output Power vs. Supply Voltage @ -10 dBm Drive Level



Input Return Loss vs. Temperature



Output Return Loss vs. Temperature



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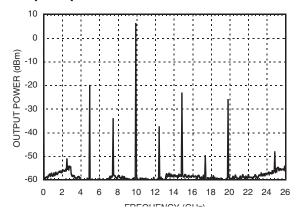
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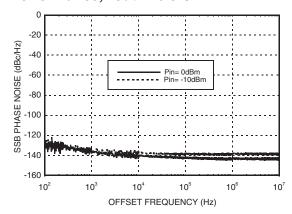


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Output Spectrum



SSB Phase Noise Performance, Fout= 10.5 GHz



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Absolute Maximum Ratings

| RF Input (Vcc = +5V) | +20 dBm |
|---|----------------|
| Vcc | +5.5V |
| Channel Temperature | 135 °C |
| Continuous Pdiss (T=85 °C) (derate 7.6 mW/°C above 85 °C) | 500 mW |
| Thermal Resistance (R _{th}) (junction to ground paddle) | 130.8 °C/W |
| Storage Temperature | -65 to +150 °C |
| Operating Temperature | -40 to +85 °C |

Typical Supply Current vs. Vcc

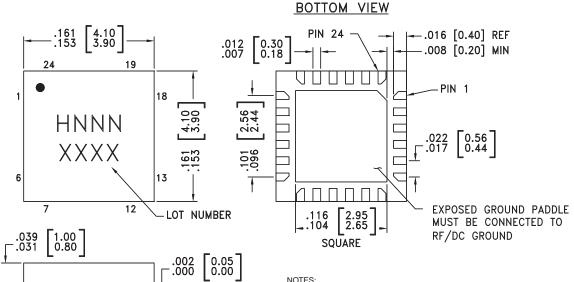
| Vcc (V) | Icc (mA) | |
|---------|----------|--|
| 4.5 | 51 | |
| 5.0 | 52 | |
| 5.5 | 54 | |

Note: Multiplier will operate over full voltage range shown above.



ELECTROSTATIC SENSITIVE DEVICE **OBSERVE HANDLING PRECAUTIONS**

Outline Drawing



SEATING

PLANE

-C-

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM. PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

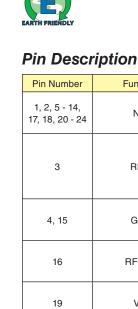
.003[0.08] c

| Part Number | Package Body Material | Lead Finish | MSL Rating | Package Marking [3] |
|-------------|--|---------------|------------|---------------------|
| HMC443LP4 | Low Stress Injection Molded Plastic | Sn/Pb Solder | MSL1 [1] | H443 XXXX |
| HMC443LP4E | RoHS-compliant Low Stress Injection Molded Plastic | 100% matte Sn | MSL1 [2] | H443 XXXX |

- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260 °C
- [3] 4-Digit lot number XXXX

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ANALOGDEVICES

| Pin Number | Function | Description | Interface Schematic |
|----------------------------------|----------|--|---------------------|
| 1, 2, 5 - 14, 17, 18, 20 - 24 | N/C | The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally. | |
| 3 | RFIN | RF input needs to be DC blocked only if there is an external DC voltage applied to RF IN. | RFIN ○ |
| 4, 15 | GND | All ground leads and ground paddle must be soldered to PCB RF/DC ground. | ○ GND = |
| 16 | RFOUT | Multiplied Output. AC coupled. No external DC blocks necessary. | — —○ RFOUT |
| 19 | Vcc | Supply voltage 5V ± 0.5V. | |

ANALOGDEVICES

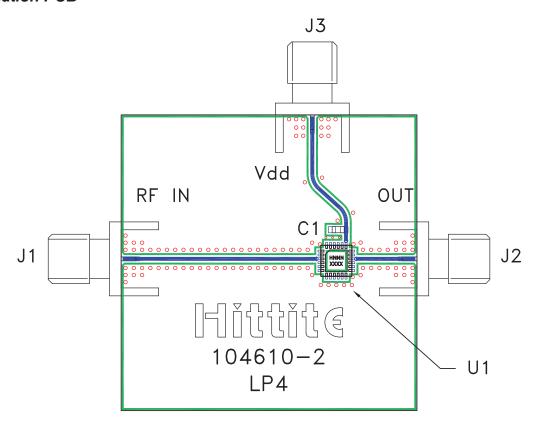
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Evaluation PCB



List of Materials for Evaluation PCB 106137 [1]

| Item | Description |
|---------|--|
| J1 - J3 | PCB Mount SMA Connector |
| C1 | 1,000 pF Capacitor, 0603 Pkg. |
| U1 | HMC443LP4 / HMC443LP4E x4 Active Multiplier |
| PCB [2] | 104610 Eval Board |

^[1] Reference this number when ordering complete evaluation PCB

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. The evaluation circuit board shown is available from Hittite upon request.

^[2] Circuit Board Material: Rogers 4350